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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): TENMEI et al.
Serial No.: 09/698,168
Filed: October 30, 2000
For: SEMICONDUCTOR DEVICE
Group: 2814
Examiner: D. Nguyen

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**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR 1.97 & 1.98**

Assistant Commissioner
for Patents
Washington, D.C. 20231

January 30, 2003

#12
D. Scott
4/7/03

Sir:

In the matter of the above-identified application, applicants are submitting herewith copies of the documents listed in the attached form equivalent to Form PTO-1449 for the Examiner's consideration.

This information disclosure statement is being submitted, on information and belief, before the mailing date of a first office action on the merits and is accompanied by the following certification specified in 37 CFR 1.97(e):

On information and belief, I hereby certify that no item of information in the information disclosure statement filed herewith was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge after making reasonable inquiry, was known to any individual designated in 1.56(c) more than three months prior to the filing of this information disclosure statement.

To the extent the documents listed on the attached form equivalent to Form PTO-1449 are not in the English language, the requirement of 37 CFR 1.98(a)(3) for a concise explanation of the relevance is satisfied by an English language abstract of each of the documents provided herein.